



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



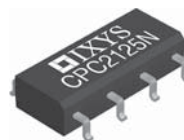
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| Parameter                         | Rating | Units                |
|-----------------------------------|--------|----------------------|
| Blocking Voltage                  | 400    | $V_P$                |
| Load Current                      | 100    | $mA_{rms} / mA_{DC}$ |
| On-Resistance (max)               | 35     | $\Omega$             |
| LED Forward Current (to Activate) | 2      | mA                   |

### Features

- 1500V<sub>rms</sub> Input/Output Isolation
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Immune to Radiated EM Fields
- Wave Solderable
- Tape & Reel Version Available
- Small 8-Pin SOIC Package

### Applications

- Telecommunications
  - Telecom Switching
  - Tip/Ring Circuits
  - Modem Switching (Laptop, Notebook, Pocket Size)
  - Hook Switch
  - Dial Pulsing
  - Ground Start
  - Ringing Injection
- Security
  - Passive Infrared Detectors (PIR)
  - Data Signaling
  - Sensor Circuitry
- Instrumentation
  - Multiplexers
  - Data Acquisition
  - Electronic Switching
  - I/O Subsystems
- Medical Equipment—Patient/Equipment Isolation
- Aerospace
- Industrial Controls

### Description

The CPC2125N is a miniature device with two independent normally-closed (1-Form-B) solid state relays in an 8-pin SOIC package that employs optically coupled MOSFET technology to provide 1500V<sub>rms</sub> of input to output isolation.

Optically coupled outputs, using the patented OptoMOS architecture, are controlled by a highly efficient infrared LED.

Constructed using IXYS Integrated Circuits Division's state of the art double-molded, vertical construction packaging, this device is one of the world's smallest relays. It offers substantial board space savings over the competitor's larger 8-pin SOIC relay.

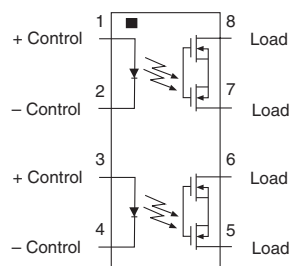
### Approvals

- UL Recognized Component: File E76270
- CSA Approval Pending
- EN/IEC 60950-1 Certified Component:  
TUV Certificate B 13 12 82667 003

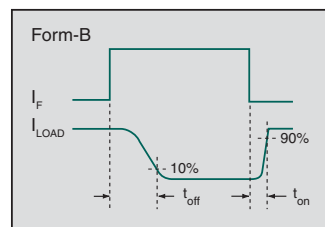
### Ordering Information

| Part #     | Description            |
|------------|------------------------|
| CPC2125N   | 8-Pin SOIC (50/tube)   |
| CPC2125NTR | 8-Pin SOIC (2000/reel) |

### Pin Configuration



### Switching Characteristics of Normally-Closed (Form-B) Devices



## Absolute Maximum Ratings @ 25°C

| Parameter                                       | Ratings     | Units            |
|---|-------------|------------------|
| Blocking Voltage                                | 400         | V <sub>P</sub>   |
| Reverse Input Voltage                           | 5           | V                |
| LED Forward Current                             | 50          | mA               |
| Peak (10ms)                                     | 1           | A                |
| Input Power Dissipation                         | 70          | mW               |
| Total Power Dissipation <sup>1</sup>            | 600         | mW               |
| Isolation Voltage, Input to Output (60 Seconds) | 1500        | V <sub>rms</sub> |
| ESD Rating, Human Body Model                    | 8           | kV               |
| Operational Temperature                         | -40 to +85  | °C               |
| Storage Temperature                             | -40 to +125 | °C               |

<sup>1</sup> Derate linearly 5mW / °C

*Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.*

*Typical values are characteristic of the device at +25°C, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements.*

## Electrical Characteristics @ 25°C

| Parameter                     | Conditions                                       | Symbol            | Min | Typ  | Max  | Units                                |
|-------------------------------|--|-------------------|-----|------|------|--------------------------------------|
| <b>Output Characteristics</b> |  |                   |     |      |      |                                      |
| Load Current                  |  |                   |     |      |      |                                      |
| Continuous <sup>1</sup>       | I <sub>F</sub> =0mA                              | I <sub>L</sub>    | -   | -    | 100  | mA <sub>rms</sub> / mA <sub>DC</sub> |
| Peak                          | t=10ms   | I <sub>LPK</sub>  | -   | -    | ±350 | mA <sub>P</sub>                      |
| On-Resistance <sup>2</sup>    | I <sub>L</sub> =100mA                            | R <sub>ON</sub>   | -   | 26   | 35   | Ω                                    |
| Switching Speeds              |  |                   |     |      |      |                                      |
| Turn-On                       | I <sub>F</sub> =5mA, V <sub>L</sub> =10V         | t <sub>on</sub>   | -   | 0.31 | 2    | ms                                   |
| Turn-Off                      |  | t <sub>off</sub>  | -   | 0.30 | 2    |                                      |
| Off-State Leakage Current     | V <sub>L</sub> =400V, I <sub>F</sub> =2mA        | I <sub>LEAK</sub> | -   | -    | 5    | μA                                   |
| Output Capacitance            | I <sub>F</sub> =2mA, V <sub>L</sub> =50V, f=1MHz | C <sub>OUT</sub>  | -   | 6    | -    | pF                                   |
| <b>Input Characteristics</b>  |  |                   |     |      |      |                                      |
| LED Forward Current           |  |                   |     |      |      |                                      |
| To Activate <sup>3</sup>      | I <sub>L</sub> =100mA                            | I <sub>F</sub>    | -   | -    | 2    | mA                                   |
| To Deactivate                 |  |                   | 0.1 | -    | -    |                                      |
| Input Voltage Drop            | I <sub>F</sub> =5mA                              | V <sub>F</sub>    | 0.9 | 1.2  | 1.4  | V                                    |
| Reverse Input Current         | V <sub>R</sub> =5V                               | I <sub>R</sub>    | -   | -    | 10   | μA                                   |
| <b>Common Characteristics</b> |  |                   |     |      |      |                                      |
| Capacitance, Input to Output  | V <sub>IO</sub> =0V, f=1MHz                      | C <sub>IO</sub>   | -   | 1    | -    | pF                                   |

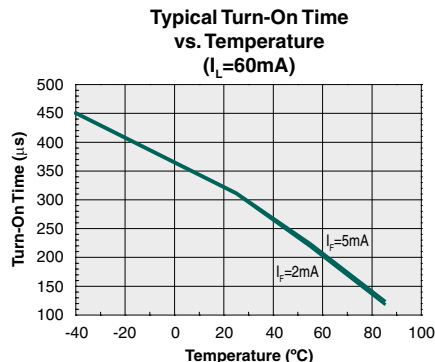
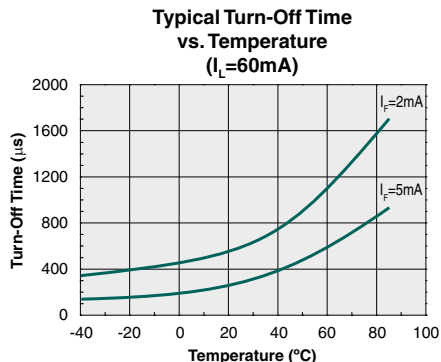
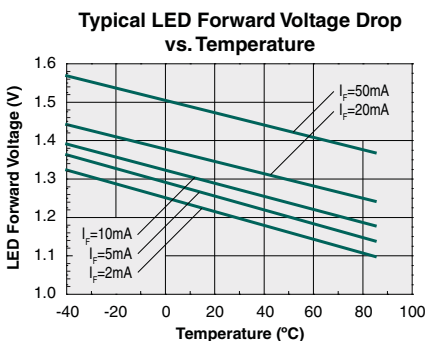
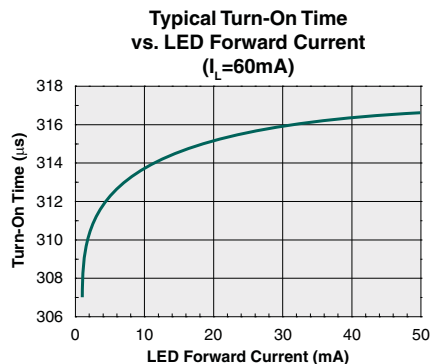
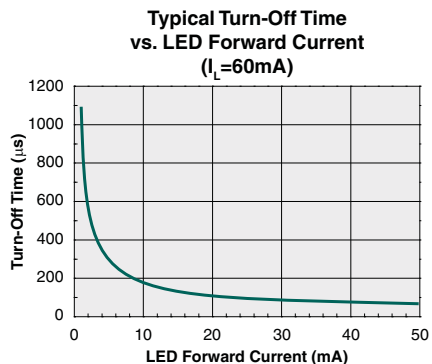
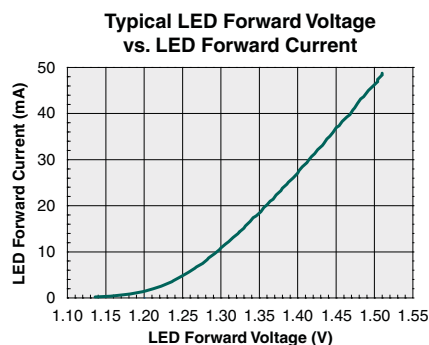
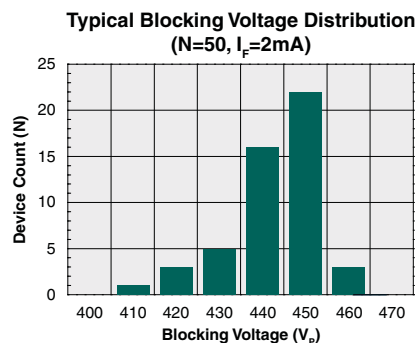
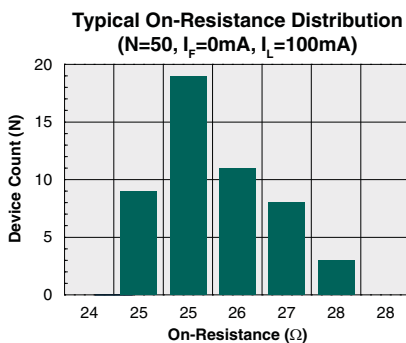
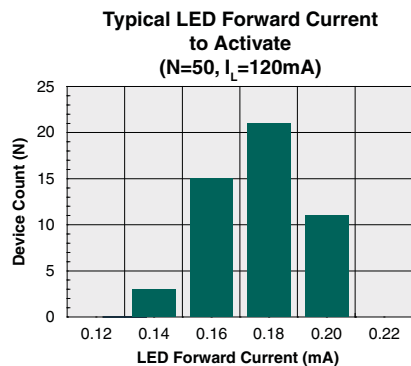
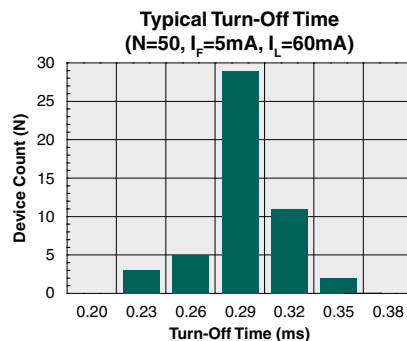
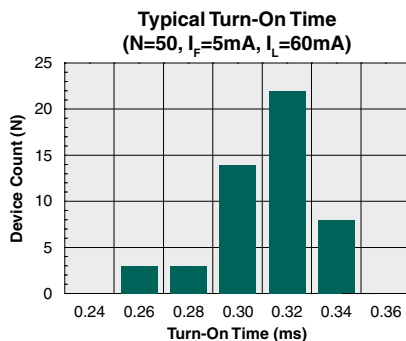
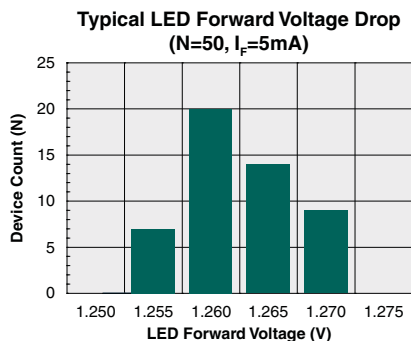
<sup>1</sup> Load current derates linearly from 100mA @ 25°C to 60mA @ 85°C, and must be derated if both poles are operating simultaneously.

<sup>2</sup> Measurement taken within 1 second of on-time.

<sup>3</sup> For applications requiring high temperature operation (greater than 60°C) a minimum LED forward current of 4mA is recommended.

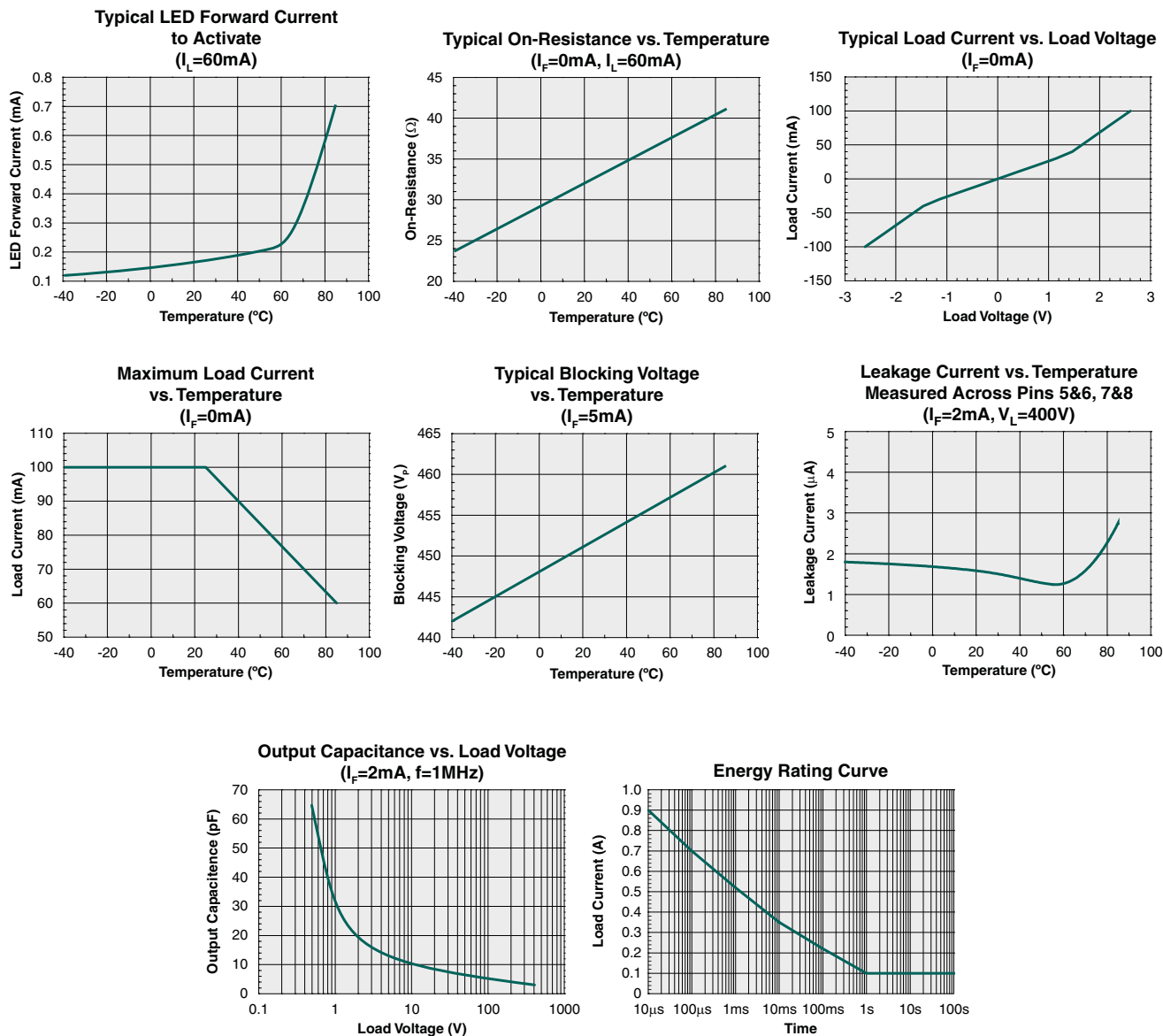


# PERFORMANCE DATA @ 25°C (Unless Otherwise Noted) \*



\*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

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## Manufacturing Information

### Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

| Device   | Moisture Sensitivity Level (MSL) Rating |
|----------|---|
| CPC2125N | MSL 3                                   |

### ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

### Soldering Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

| Device   | Maximum Temperature x Time | Maximum Reflow Cycles |
|----------|----------------------------|-----------------------|
| CPC2125N | 260°C for 30 seconds       | 3                     |

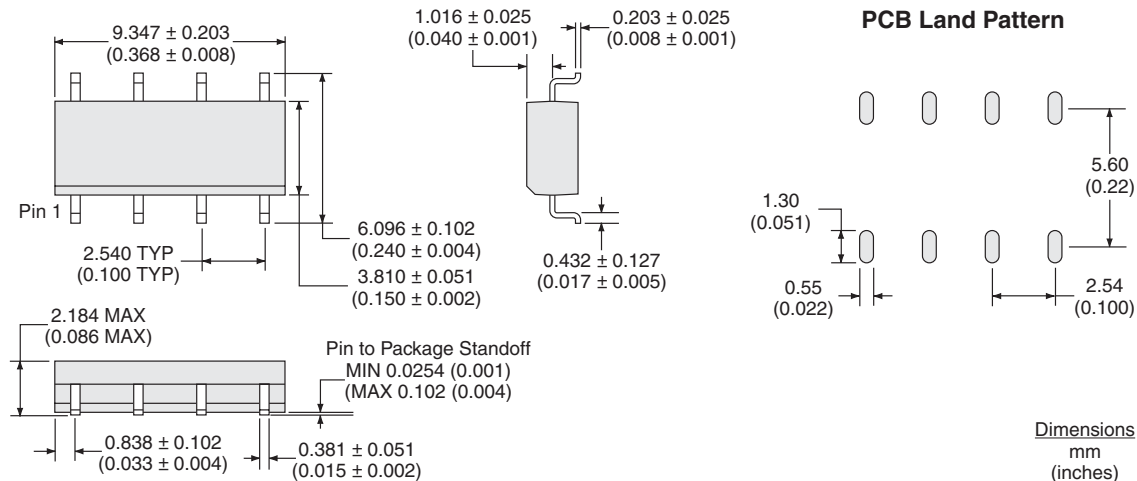
### Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after soldering processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

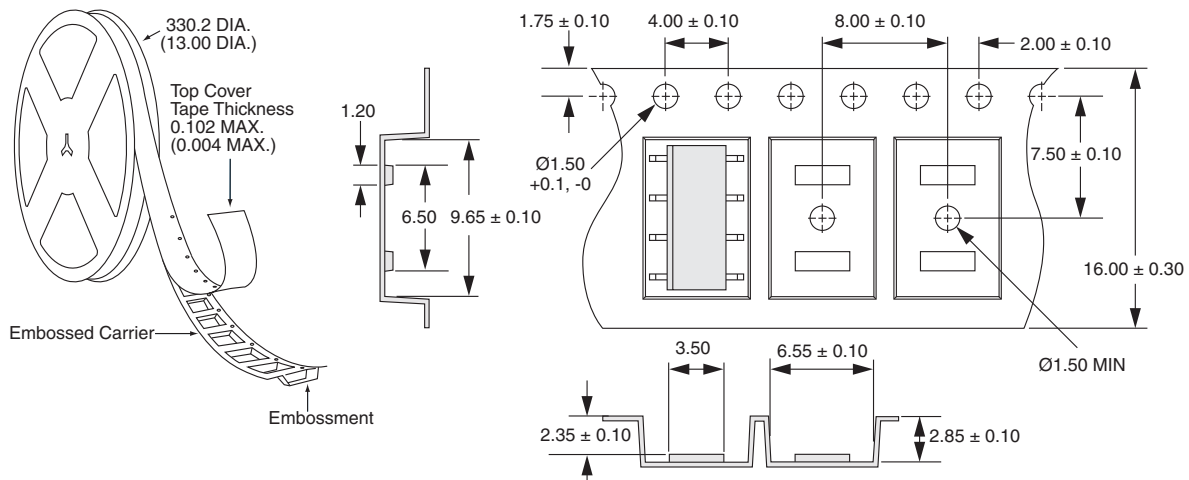


## MECHANICAL DIMENSIONS

### CPC2125N



### CPC2125NTR Tape & Reel



#### NOTES:

1. All dimensions in millimeters
2. 10 sprocket hole pitch cumulative tolerance ± 0.20.
3. Carrier camber is within 1mm in 250mm.
4. Tape material : Black Conductive Polystyrene Alloy.
5. All dimensions meet EIA-481-C requirements.
6. Thickness : 0.30 ± 0.05mm.

For additional information please visit our website at: [www.ixysic.com](http://www.ixysic.com)

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